PD - 95629

 $I_{D}$ 

17A

# International

## IRFB17N60KPbF

R<sub>DS(on)</sub> typ.

**0.35**Ω

### SMPS MOSFET

V<sub>DSS</sub>

600V

### HEXFET<sup>®</sup> Power MOSFET

#### Applications

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply
- High Speed Power Switching
- Hard Switched and High Frequency Circuits
- Lead-Free

### Benefits

- Smaller TO-220 Package
- Low Gate Charge Qg results in Simple Drive Requirement
- Improved Gate, Avalanche and Dynamic dv/dt Ruggedness
- Fully Characterized Capacitance and Avalanche Voltage and Current

(150)
TO-220AB

#### **Absolute Maximum Ratings**

	Parameter	Max.	Units
I <sub>D</sub> @ T <sub>C</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	17	
I <sub>D</sub> @ T <sub>C</sub> = 100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	11	A
IDM	Pulsed Drain Current ①	68	
$P_D @T_C = 25^{\circ}C$	Power Dissipation	340	W
	Linear Derating Factor	2.7	W/ºC
V <sub>GS</sub>	Gate-to-Source Voltage	± 30	V
dv/dt	Peak Diode Recovery dv/dt 3	11	V/ns
TJ	Operating Junction and	-55 to + 150	
T <sub>STG</sub>	Storage Temperature Range		
	Soldering Temperature, for 10 seconds	300	•C
	(1.6mm from case)		
	Mounting Torque, 6-32 or M3 screw	10	N

#### Avalanche Characteristics

Symbol	Parameter	Тур.	Max.	Units
E <sub>AS</sub>	Single Pulse Avalanche Energy®		330	mJ
I <sub>AR</sub>	Avalanche Current@		17	A
E <sub>AR</sub>	Repetitive Avalanche Energy®		34	mJ

#### **Thermal Resistance**

Symbol	Parameter	Тур.	Max.	Units
R <sub>eJC</sub>	Junction-to-Case		0.37	
Recs	Case-to-Sink, Flat, Greased Surface	0.50		•C/W
Roja	Junction-to-Ambient		58	

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### Static @ T<sub>J</sub> = 25°C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
V(BR)DSS	Drain-to-Source Breakdown Voltage	600			V	$V_{GS} = 0V, I_D = 250 \mu A$
$\Delta V_{(BRiDSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.60		V/°C	Reference to $25^{\circ}$ C, I <sub>D</sub> = 1mA
R <sub>DS(on)</sub>	Static Drain-to-Source On-Resistance		0.35	0.42	Ω	$V_{GS}$ = 10V, $I_D$ = 10A $\oplus$
$V_{GS(th)}$	Gate Threshold Voltage	3.0		5.0	٧	$V_{DS} = V_{GS}, I_D = 250 \mu A$
	Drain to Source Lockogo Current			50	μA	$V_{\rm DS} = 600V, V_{\rm GS} = 0V$
IDSS	Drain-to-Source Leakage Current			250	μA	$V_{DS} = 480V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
1	Gate-to-Source Forward Leakage			100		V <sub>GS</sub> = 30V
GSS	Gate-to-Source Reverse Leakage			-100	- nA	V <sub>GS</sub> = -30V

#### Dynamic @ T<sub>J</sub> = 25°C (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Units	Conditions
<b>g</b> fs	Forward Transconductance	5.9			S	$V_{DS} = 50V, I_D = 10A$
Qg	Total Gate Charge			99		I <sub>D</sub> = 17A
Q <sub>gs</sub>	Gate-to-Source Charge			32	nC	V <sub>DS</sub> = 480V
Qgd	Gate-to-Drain ("Miller") Charge			47		$V_{GS}$ = 10V, See Fig. 6 and 13 $\oplus$
t <sub>d(on)</sub>	Turn-On Delay Time		25			V <sub>DD</sub> = 300V
t <sub>r</sub>	Rise Time		82		ns	I <sub>D</sub> = 17A
t <sub>d(off)</sub>	Turn-Off Delay Time		38			R <sub>G</sub> = 7.5Ω
tí	Fall Time		32		1	$V_{GS}$ = 10V,See Fig. 10 ④
Ciss	Input Capacitance		2700			$V_{GS} = 0V$
Coss	Output Capacitance		240			$V_{DS} = 25V$
C <sub>rss</sub>	Reverse Transfer Capacitance		21		рF	f = 1.0MHz, See Fig. 5
Coss	Output Capacitance		2950		1	$V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz$
Coss	Output Capacitance		67			$V_{GS} = 0V, V_{DS} = 480V, f = 1.0MHz$
C <sub>oss</sub> eff.	Effective Output Capacitance		120			$V_{\text{GS}}$ = 0V, $V_{\text{DS}}$ = 0V to 480V $\circledast$

#### **Diode Characteristics**

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions	
I <sub>S</sub>	Continuous Source Current			17		MOSFET symbol	
	(Body Diode)				A	showing the	
Ism	Pulsed Source Current			68			integral reverse 🔍 🛄
	(Body Diode) ①						p-n junction diode.
V <sub>SD</sub>	Diode Forward Voltage			1.5	V	$T_{\rm J}=25^{\circ}C,\ I_{\rm S}=17A,\ V_{\rm GS}=0V  \textcircled{\oplus}$	
t <sub>rr</sub>	Reverse Recovery Time		520	780	ns	T <sub>J</sub> = 25°C, I <sub>F</sub> = 17A	
Q <sub>rr</sub>	Reverse RecoveryCharge		5620	8430	nC	di/dt = 100A/µs   ⊘	
t <sub>rr</sub>	Reverse Recovery Time		580	870	ns	T <sub>J</sub> = 125°C, I <sub>F</sub> = 17A	
Q <sub>rr</sub>	Reverse RecoveryCharge		6470	9700	nC	di/dt = 100A/µs	
t <sub>on</sub>	Forward Tum-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by $L_{S}+L_{D}$ )					

#### Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- 0 Starting  $T_{\rm J}$  = 25°C, L = 2.3mH,  $R_{\rm G}$  = 25 $\Omega,$   $I_{\rm AS}$  = 17A,

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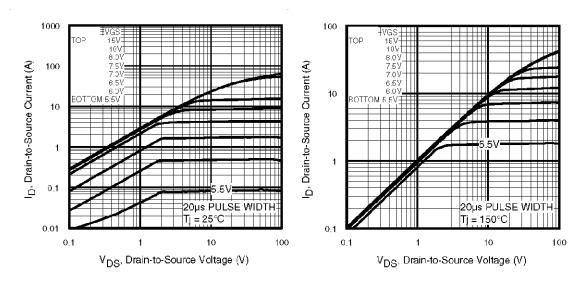


Fig 1. Typical Output Characteristics

Fig 2. Typical Output Characteristics

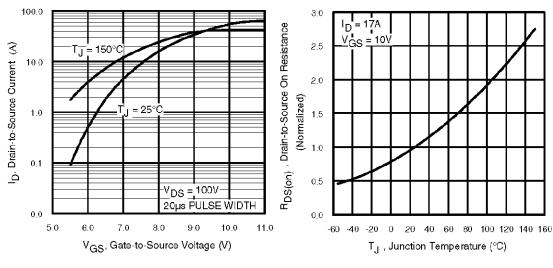


Fig 3. Typical Transfer Characteristics

Fig 4. Normalized On-Resistance Vs. Temperature

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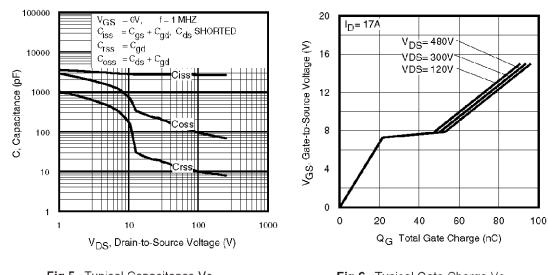


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage



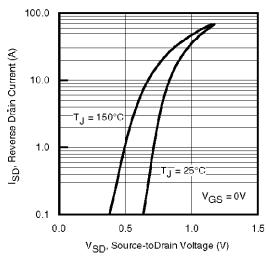


Fig 7. Typical Source-Drain Diode Forward Voltage

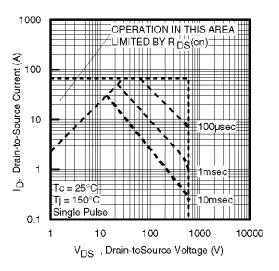
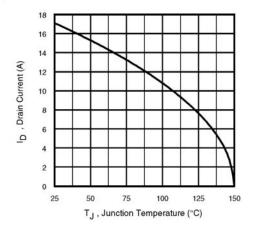


Fig 8. Maximum Safe Operating Area







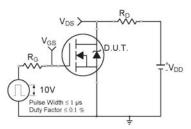


Fig 10a. Switching Time Test Circuit

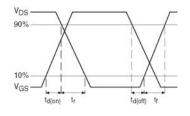


Fig 10b. Switching Time Waveforms

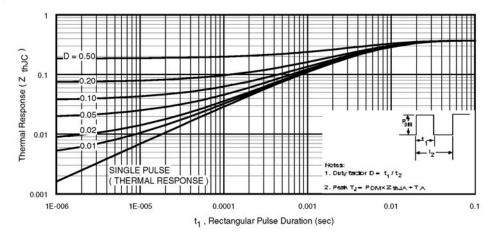
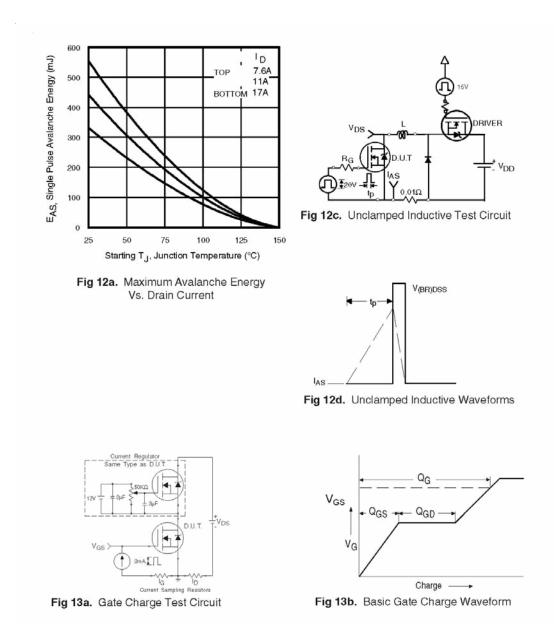
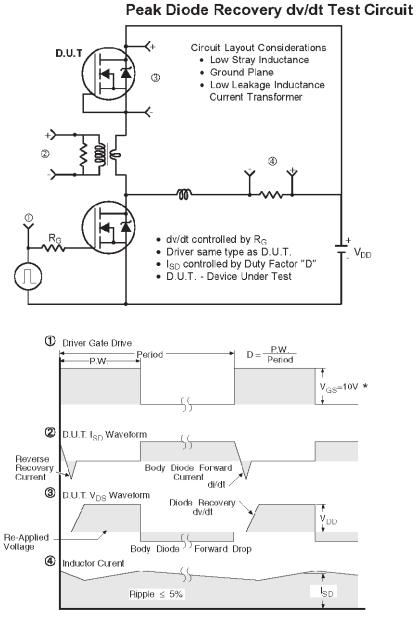


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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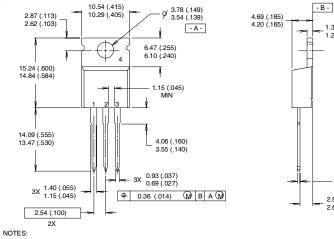
\*  $V_{GS}$  = 5V for Logic Level Devices



# International

### **TO-220AB** Package Outline

Dimensions are shown in millimeters (inches)



1 DIMENSIONING & TOLERANCING PER ANSI Y14.5M, 1982. 2 CONTROLLING DIMENSION : INCH 3 OUTLINE CONFORMS TO JEDEC OUTLINE TO-220AB. 4 HEATSINK & LEAD MEASUREMENTS DO NOT INCLUDE BURRS.

1.32 (.052)

1.22 (.048)

HEXFET

1- GATE

3X 0.55 (.022) 0.46 (.018)

2.92 (.115) 2.64 (.104)

2- DRAIN 3- SOURCE 4- DRAIN

LEAD ASSIGNMENTS

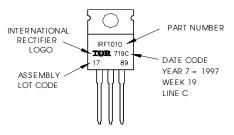
IGBTs, CoPACK

1- GATE 2- COLLECTOR 3- EMITTER 4- COLLECTOR

### **TO-220AB Part Marking Information**

EXAMPLE: THIS IS AN IRF1010 LOT CODE 1789 ASSEMBLED ON WW 19, 1997 IN THE ASSEMBLY LINE "C"

Note: "P" in assembly line position indicates "Lead-Free"



TO-220AB package is not recommended for Surface Mount Application

Data and specifications subject to change without notice. This product has been designed and qualified for the Automotive [Q101] market. Qualification Standards can be found on IR's Web site.



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